N-Channel Enhancement Mode Field Effect Transistor

Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- These Devices are Pb-Free and are RoHS Compliant
- ESD HBM = 1000 V as per JESD22 A114 and ESD CDM = 1500 V as per JESD22 C101

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	60	V
Gate-Source Voltage	V_{GSS}	±20	V
	Ι _D	310 195 1.2	mA mA A
Operating Junction Temperature Range	TJ	–55 to +150	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Total Device Dissipation Derating above T _A = 25°C	P_{D}	300 2.4	mW mW/°C
Thermal Resistance, Junction to Ambient*	$R_{ heta JA}$	410	°C/W

^{*}Device mounted on FR-4 PCB, 1" x 0.85" x 0.062". Minimum land pad size



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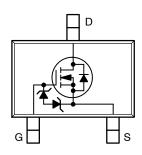


SC-70 3 LEAD CASE 419AB

MARKING DIAGRAM



7KW = Specific Device Marking



ORDERING INFORMATION[†]

Device	Package	Shipping [†]
2N7002KW	SC-70	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
FF CHARAC	TERISTICS					<u> </u>
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 10 μA	60	-	_	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 60 V, V _{GS} = 0 V V _{DS} = 60 V, V _{GS} = 0 V, T _J = 125°C	-	-	1.0 0.5	μA mA
I _{GSS}	Gate-Body Leakage	V _{DS} = 0 V, V _{GS} = ±20 V	-	-	±10	μΑ
N CHARACT	ERISTICS (Note 1)					-
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.1	-	2.1	V
R _{DS(on)}	Static Drain-Source On-Resistance	$\begin{aligned} &V_{GS} = 10 \text{ V, } I_D = 500 \text{ mA} \\ &V_{GS} = 10 \text{ V, } I_D = 500 \text{ mA, } T_J = 100^{\circ}\text{C} \\ &V_{GS} = 5 \text{ V, } I_D = 50 \text{ mA} \\ &V_{GS} = 5 \text{ V, } I_D = 50 \text{ mA, } T_J = 100^{\circ}\text{C} \end{aligned}$	-	-	1.6 2.4 2 3	Ω
V _{DS(on)}	Drain-Source On-Voltage	$V_{GS} = 10 \text{ V}, I_D = 500 \text{ mA}$ $V_{GS} = 5 \text{ V}, I_D = 50 \text{ mA}$	-	-	3.75 1.5	V
I _{D(on)}	On-State Drain Current	V _{GS} = 10 V, V _{DS} = 2 V	500	-	-	mA
9 _{FS}	Forward Transconductance	V _{DS} = 2 V, I _D = 0.2 A	80	-	-	mS
YNAMIC CHA	ARACTERISTICS					
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz	_	-	50	pF
C _{oss}	Output Capacitance]	-	-	25	pF
C _{rss}	Reverse Transfer Capacitance]	-	-	5	pF
WITCHING C	HARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 30 \text{ V}, R_L = 150 \Omega, V_{GS} = 10 \text{ V},$	-	-	20	ns
t _{d(off)}	Turn-Off Delay Time	I_D = 200 mA, R_{GEN} = 25 Ω	-	-	60	ns
RAIN-SOUR	CE DIODE CHARACTERISTICS					
IS	Maximum Continuous Drain-Source D	iode Forward Current	-	-	115	mA
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		-	-	0.8	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 115 mA	_	_	1.1	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width < 300 µs, Duty Cycle < 2.0%.

TYPICAL PERFORMANCE CHARACTERISTICS

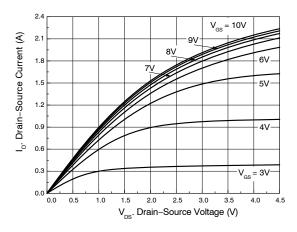


Figure 1. On-Region Characteristics

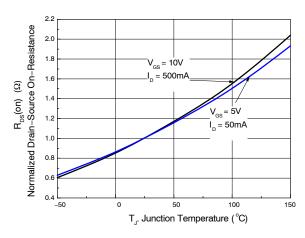


Figure 2. On–Resistance Variation with Temperature

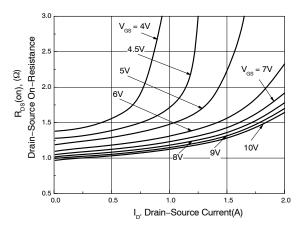


Figure 3. On-Resistance Variation with Gate Voltage and Drain Current

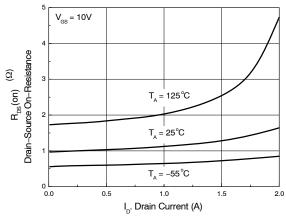


Figure 4. On–Resistance Variation with Drain Current and Temperature

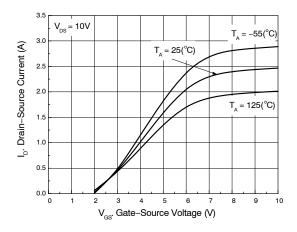


Figure 5. Transfer Characteristics

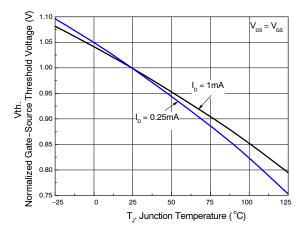


Figure 6. Gate Threshold Variation with Temperature

TYPICAL PERFORMANCE CHARACTERISTICS

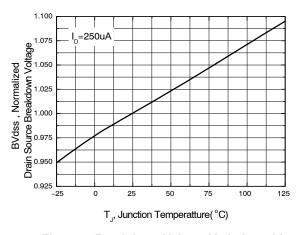


Figure 7. Breakdown Voltage Variation with Temperature

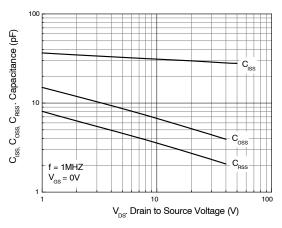


Figure 9. Capacitance Variation

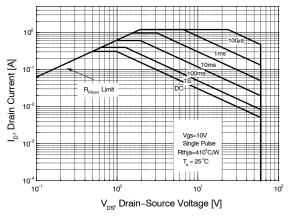


Figure 11. Maximum Safe Operating Area

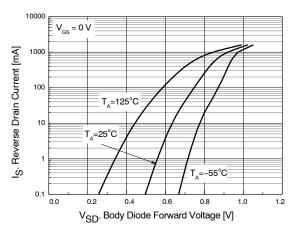


Figure 8. Body Diode Forward Voltage Variation with Source Current and Temperature

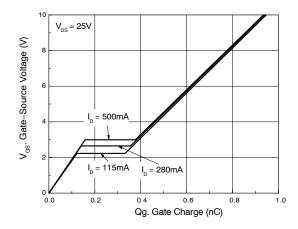


Figure 10. Gate Charge Characteristics

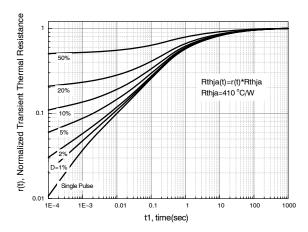
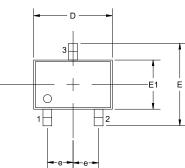


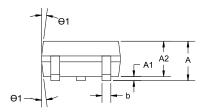
Figure 12. Transient Thermal Response Curve



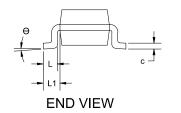




TOP VIEW



SIDE VIEW



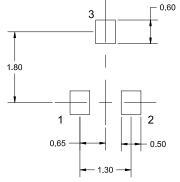
SC-70, 3 Lead, 1.25x2 CASE 419AB **ISSUE A**

DATE 13 FEB 2023

NOTES:

- 1. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES IN DEGREES.
- 2. COMPLIES WITH JEDEC MO-203

	MILLIMETERS		
DIM	MIN.	NOM.	MAX.
Α	0.80		1.10
A1	0.00		0.10
A2	0.80	0.90	1.00
b	0.15		0.30
С	0.08		0.22
D	1.80	2.00	2.20
E	1.80	2.10	2.40
E1	1.15	1.25	1.35
е	0.65 BSC		
L	0.26	0.36	0.46
L1	0.42 REF		
θ	0°		8°
Θ1	4°		10°



SOLDERING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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